1. General description

Trench Maximum Efficiency General Application (MEGA) Schottky barrier rectifier encapsulated in a CFP2-HP (SOD323HP) power flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Low forward voltage
- Low Q_{rr} and low I_{RM}
- · Low leakage current
- High power capability due to clip-bonding technology
- Power flat lead plastic package with exposed heatsink for optimal thermal connection
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- · High efficiency DC-to-DC conversion
- · Switch mode power supply
- · Freewheeling applications
- · Reverse polarity protection
- OR-ing

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _{sp} \leq 166 °C		-	-	2	А
V _R	reverse voltage	T _j = 25 °C		-	-	45	V
V _F	forward voltage	I _F = 2 A; pulsed; T _j = 25 °C	[1]	-	500	560	mV
I _R	reverse current	V _R = 45 V; pulsed; T _j = 25 °C	[1]	-	4	25	μΑ
		V _R = 45 V; pulsed; T _j = 125 °C	[1]	-	3	9	mA

^[1] Very short pulse, in order to maintain a stable junction temperature.



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	, Th	
2	A	anode	1	K - K - A sym001
			CFP2-HP (SOD323HP)	

6. Ordering information

Table 3. Ordering information

Type number	Package						
	Name	Description	Version				
PMEG45T20EXD-Q	CFP2-HP	SOD323HP: plastic surface-mounted package with solderable lead ends; 2.2 mm x 1.3 mm x 0.68 mm body	SOD323HP				

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG45T20EXD-Q	2Ј

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_R	reverse voltage	T _j = 25 °C		-	45	V
I _F	forward current	δ = 1; $T_{sp} \le 165 ^{\circ}\text{C}$		-	2.8	А
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; $T_{sp} \le$ 166 °C		-	2	Α
I _{FSM}	non-repetitive peak forward current	t_p = 8.3 ms; half sine wave; $T_{j(init)}$ = 25 °C		-	22	Α
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	0.65	W
			[2]	-	1.2	W
T _j	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

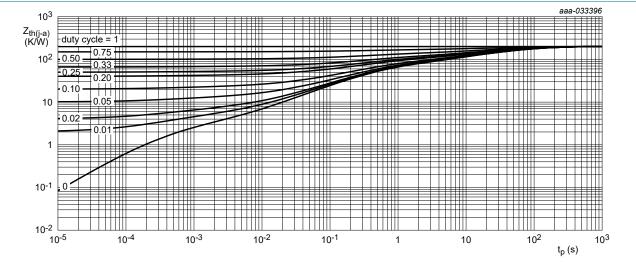
^[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm 2 .

9. Thermal characteristics

Table 6. Thermal characteristics

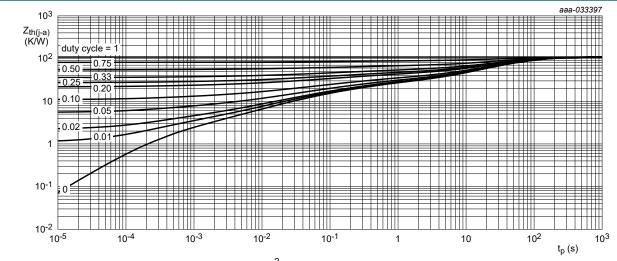
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from	in free air	[1] [2]	-	-	230	K/W
jı	junction to ambient		[1] [3]	-	-	125	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		[4]	-	-	6	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm²

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

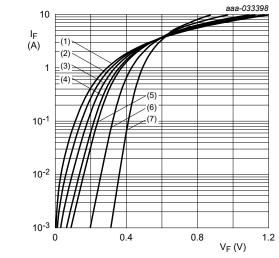
Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	I _R = 1 mA; pulsed; T _j = 25 °C	[1]	45	-	-	V
V _F	forward voltage	I _F = 0.1 A; pulsed; T _j = 25 °C	[1]	-	330	385	mV
		I _F = 0.5 A; pulsed; T _j = 25 °C	[1]	-	390	445	mV
		I _F = 0.7 A; pulsed; T _j = 25 °C	[1]	-	410	465	mV
		I _F = 1 A; pulsed; T _j = 25 °C	[1]	-	430	490	mV
		I _F = 2 A; pulsed; T _j = 25 °C	[1]	-	500	560	mV
		I _F = 2 A; pulsed; T _j = -40 °C	[1]	-	540	600	mV
		I _F = 2 A; pulsed; T _j = 125 °C	[1]	-	440	500	mV
		I _F = 2 A; pulsed; T _j = 150 °C	[1]	-	430	490	mV
R	reverse current	V _R = 10 V; pulsed; T _j = 25 °C	[1]	-	2	10	μΑ
		V _R = 45 V; pulsed; T _j = 25 °C	[1]	-	4	25	μΑ
		V _R = 45 V; pulsed; T _j = 125 °C	[1]	-	3	9	mA
		V _R = 45 V; pulsed; T _j = 150 °C	[1]	-	11	40	mA
C _d	diode capacitance	V _R = 4 V; f = 1 MHz; T _j = 25 °C		-	160	-	pF
		V _R = 10 V; f = 1 MHz; T _j = 25 °C		-	100	-	pF
t _{rr}	reverse recovery time step recovery	$I_F = 0.5 \text{ A}; I_R = 1 \text{ A}; I_{R(meas)} = 0.25 \text{ A};$ $T_j = 25 \text{ °C}$		-	5	-	ns
	reverse recovery time ramp recovery	$dI_F/dt = 100 \text{ A/}\mu\text{s}; I_F = 1 \text{ A}; V_R = 30 \text{ V};$ $T_j = 25 \text{ °C}$		-	9	-	ns
l _{RM}	peak reverse recovery current			-	0.38	-	Α
Q _{rr}	reverse recovery charge			-	2.5	-	nC
V_{FRM}	peak forward recovery voltage	$I_F = 0.5 \text{ A}; \text{ d}I_F/\text{d}t = 20 \text{ A/}\mu\text{s}; T_j = 25 °C$		-	405	-	mV

^[1] Very short pulse, in order to maintain a stable junction temperature.

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45 V, 2 A Trench MEGA Schottky barrier rectifier



pulsed condition

(1) Tj = 175 °C

(2) Tj = 150 °C

(3) Tj = 125 °C

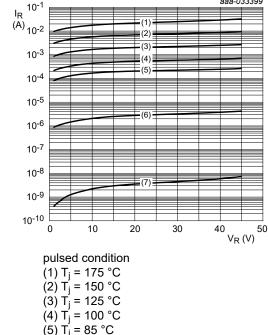
(4) Tj = 100 °C

(5) Tj = 85 °C

(6) Tj = 25 °C

(7) Tj = -40 °C

Fig. 3. Forward current as a function of forward voltage; typical values



(5) $T_j' = 85 \,^{\circ}\text{C}$ (6) $T_j = 25 \,^{\circ}\text{C}$ (7) $T_j = -40 \,^{\circ}\text{C}$

rward Fig. 4. Reverse current as a function of reverse voltage; typical values

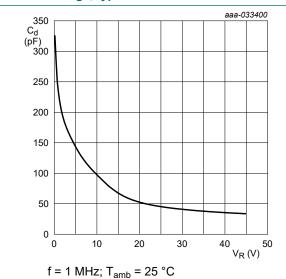
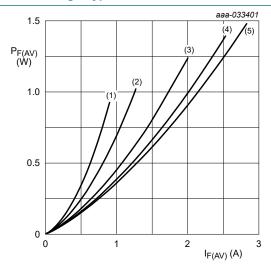
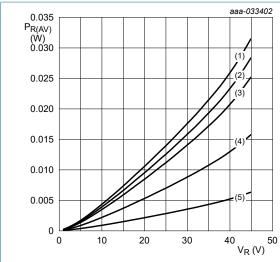


Fig. 5. Diode capacitance as a function of reverse voltage; typical values



 $T_j = 100 \,^{\circ}\text{C}$ $(1) \, \delta = 0.1$ $(2) \, \delta = 0.2$ $(3) \, \delta = 0.5$ $(4) \, \delta = 0.8$ $(5) \, \delta = 1; \, DC$

Fig. 6. Average forward power dissipation as a function of average forward current; typical values



T_j = 100 °C

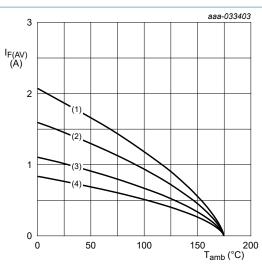
 $(1) \delta = 1$; DC

 $(2) \delta = 0.9$

 $(3) \delta = 0.8$

 $(4) \delta = 0.5$ (5) $\delta = 0.2$

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T_i = 175 °C

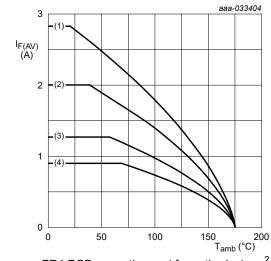
 $(1) \delta = 1$; DC

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²

T_i = 175 °C

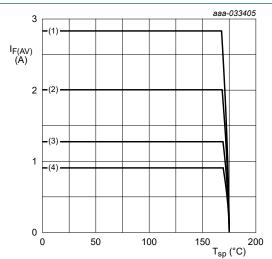
(1) $\delta = 1$; DC

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



Tj = 175 °C

(1) δ = 1; DC

(2) δ = 0.5; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

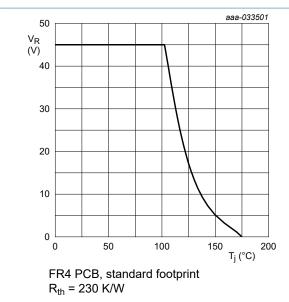
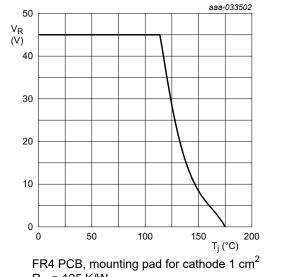
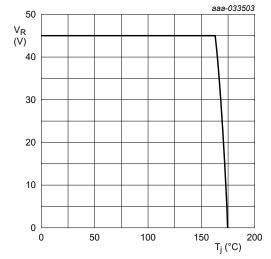


Fig. 11. Derated maximum reverse voltage as a function | Fig. 12. Derated maximum reverse voltage as a function of junction temperature; typical values



 $R_{th} = 125 \text{ K/W}$

of junction temperature; typical values



Soldering point of cathode tab $R_{th} = 6 \text{ K/W}$

Fig. 13. Derated maximum reverse voltage as a function of junction temperature; typical values

11. Test information

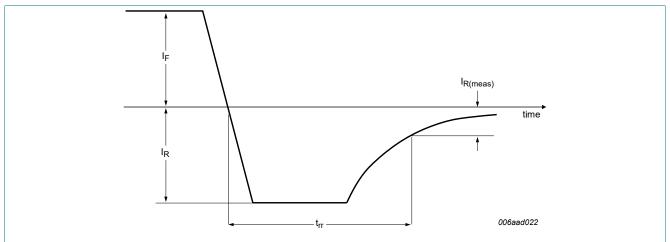


Fig. 14. Reverse recovery definition; step recovery

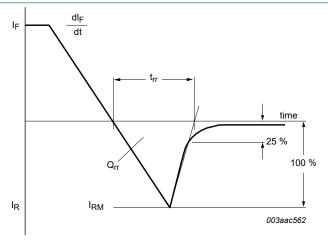


Fig. 15. Reverse recovery definition; ramp recovery

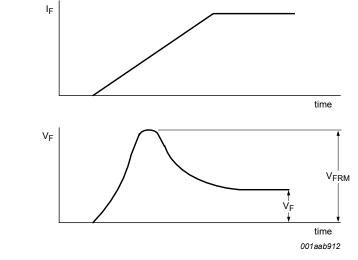
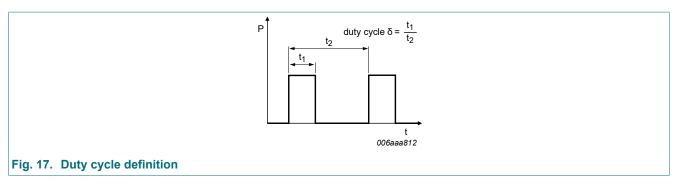


Fig. 16. Forward recovery definition



The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current

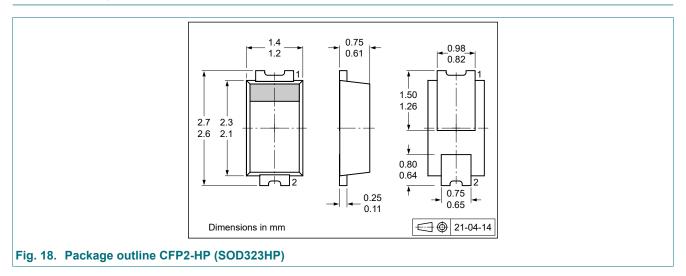
 $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$

with I_{RMS} defined as RMS current.

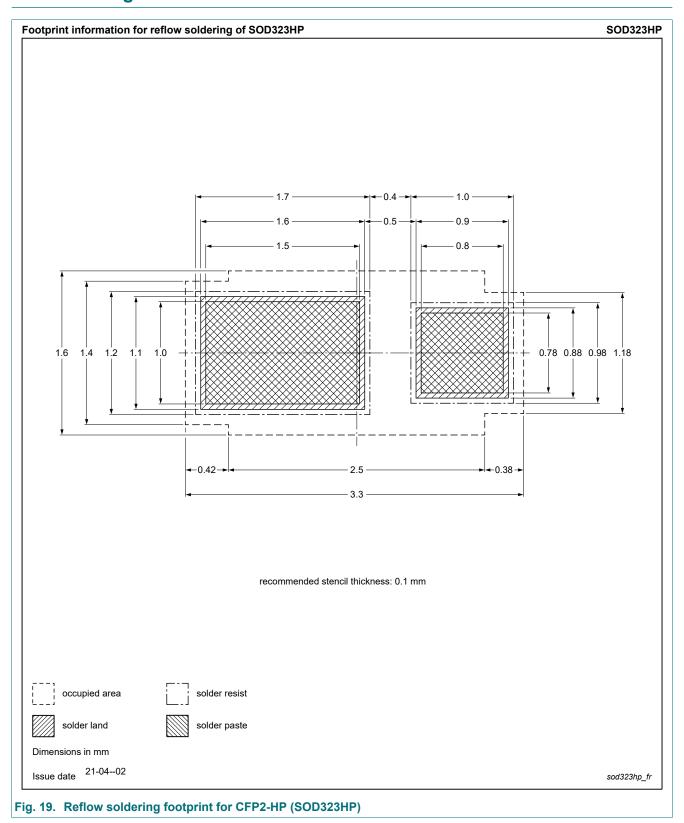
Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering



14. Revision history

Table 8. Revision history

Data sheet ID	Release date		Change notice	Supersedes
PMEG45T20EXD-Q v.1	20210618	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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Contents

1.	General description	1
2.	Features and benefits	1
3.	Applications	1
4.	Quick reference data	1
5.	Pinning information	2
6.	Ordering information	2
7.	Marking	2
8.	Limiting values	2
9.	Thermal characteristics	3
10	. Characteristics	4
11.	. Test information	8
12	. Package outline	9
	. Soldering	
	. Revision history	
	. Legal information	

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